



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# Inductors for Power Circuits

Multilayer Ferrite

**MLP Series**

## MLP2012 Type

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**MLP2012**

**2012 [0805 inch]\***

\* Dimensions Code JIS[EIA]

## REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

### SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

#### REMINDERS

- The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less).  
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.  
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.  
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.  
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.  
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.  
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/Aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

# Inductors for Power Circuits

## Multilayer Ferrite

Product compatible with RoHS directive  
Halogen-free  
Compatible with lead-free solders

# Overview of MLP2012 Type

## FEATURES

- A low-loss magnetic material is used so that a low-loss inductor for the power supply circuit can be achieved.
- In addition to the inductance value, product types with various features are available so that they can be compatible with different usages.
  - H Type: This product uses a low-loss material and has low DC resistance.
    - \* Optimal for when heavy load power efficiency is important.
  - V Type: As with the H type, this product with a low-loss magnetic material and that has good DC superimposition type characteristics.
    - \* Optimal for when light load power efficiency is important.
  - S Type: STD product lineup that includes a wide L value and various sizes.

## APPLICATION

Smart phones, tablet terminals, digital cameras, video cameras, HDDs, power supply modules, etc.

## PART NUMBER CONSTRUCTION

MLP	2012		H	R47		M	T		0S1		
Series name	L×W Dimensions (mm)		Characteristic type		Inductance (μH)		Height (mm max.)		Packaging style	Internal code	
	2012	2.0×1.25	H	Low core loss (Emphasized DC resistance)	R47	0.47	T	0.55	T	Taping	0S1
					1R0	1.0	M	1.0			
			V	Low core loss (Emphasized DC bias characteristics)							
			S	STD product							

## OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT


Type	Temperature range		Package quantity (pieces/reel)	Individual weight (mg)
	Operating temperature* (°C)	Storage temperature** (°C)		
MLP2012	t=0.55	-40 to +125	4,000	7
	t=1.0			10

\* Operating temperature range includes self-temperature rise.

\*\* The Storage temperature range is for after the circuit board is mounted.

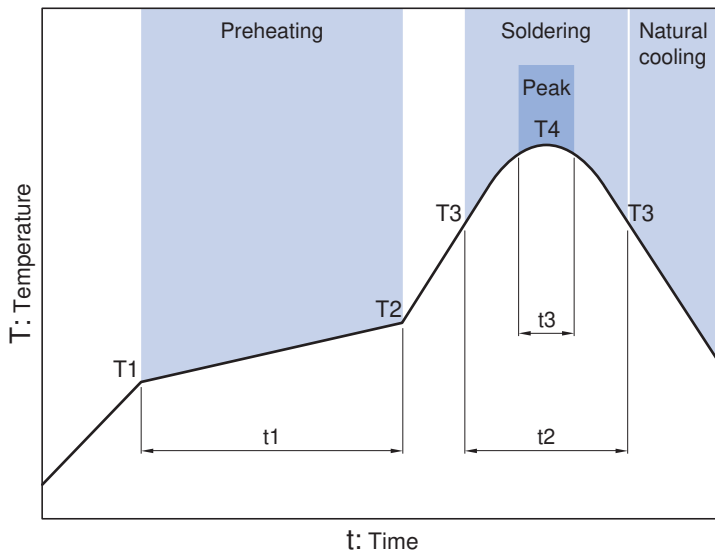
○ RoHS Directive Compliant Product: See the following for more details. <https://product.tdk.com/info/en/environment/rohs/index.html>

○ Halogen-free: Indicates that Cl content is less than 900ppm, Br content is less than 900ppm, and that the total Cl and Br content is less than 1500ppm.

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use.  
Please note that the contents may change without any prior notice due to reasons such as upgrading.

# MLP2012 Type

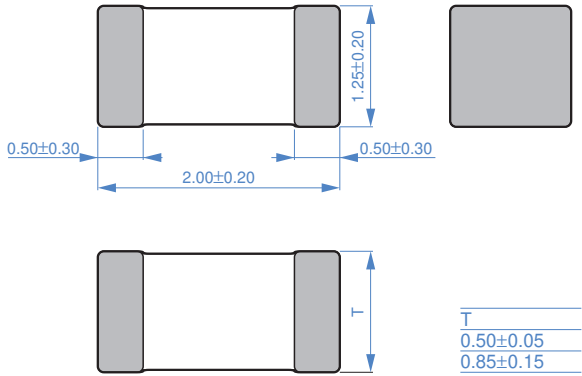
## RECOMMENDED REFLOW PROFILE



Preheating			Soldering		Peak	
Temp.	Temp.	Time	Temp.	Time	Temp.	Time
T1	T2	t1	T3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s max.

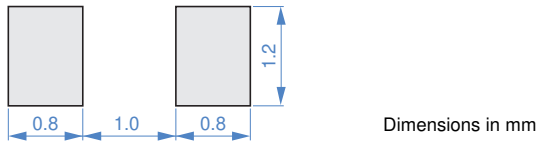
# MLP2012 Type

## SHAPE & DIMENSIONS




Dimensions in mm

## RECOMMENDED LAND PATTERN



Dimensions in mm

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

# MLP2012 Type

## ELECTRICAL CHARACTERISTICS

### CHARACTERISTICS SPECIFICATION TABLE

Type	Thickness	L		Measuring frequency	DC resistance	Rated current*	Part No.
		T (mm)max.	( $\mu$ H) tolerance				
Low core loss	Low resistance	1.0	0.47 $\pm$ 20%	2	0.07	1300	MLP2012HR47MT0S1
		1.0	0.54 $\pm$ 20%	2	0.065	1300	MLP2012HR54MT0S1
		1.0	1.0 $\pm$ 20%	2	0.12	1100	MLP2012H1R0MT0S1
		1.0	1.5 $\pm$ 20%	2	0.12	1100	MLP2012H1R5MT0S1
		1.0	2.2 $\pm$ 20%	2	0.15	1000	MLP2012H2R2MT0S1
	Emphasized DC bias characteristics	0.55	1.0 $\pm$ 20%	2	0.26	700	MLP2012V1R0TT0S1
		1.0	0.47 $\pm$ 20%	2	0.11	1100	MLP2012VR47MT0S1
		1.0	1.0 $\pm$ 20%	2	0.20	900	MLP2012V1R0MT0S1
		1.0	1.5 $\pm$ 20%	2	0.23	800	MLP2012V1R5MT0S1
		1.0	2.2 $\pm$ 20%	2	0.28	700	MLP2012V2R2MT0S1
STD product		1.0	4.7 $\pm$ 20%	2	0.40	600	MLP2012V4R7MT0S1
		0.55	0.47 $\pm$ 20%	2	0.13	1200	MLP2012SR47TT0S1
		0.55	0.82 $\pm$ 20%	2	0.13	1200	MLP2012SR82TT0S1
		0.55	1.0 $\pm$ 20%	2	0.23	800	MLP2012S1R0TT0S1
		0.55	1.5 $\pm$ 20%	2	0.27	700	MLP2012S1R5TT0S1
		0.55	2.2 $\pm$ 20%	2	0.33	600	MLP2012S2R2TT0S1
		1.0	0.47 $\pm$ 20%	2	0.09	1200	MLP2012SR47MT0S1
		1.0	1.0 $\pm$ 20%	2	0.16	1000	MLP2012S1R0MT0S1
		1.0	1.5 $\pm$ 20%	2	0.16	1000	MLP2012S1R5MT0S1
		1.0	2.2 $\pm$ 20%	2	0.23	800	MLP2012S2R2MT0S1
		1.0	3.3 $\pm$ 20%	2	0.19	900	MLP2012S3R3MT0S1
		1.0	4.7 $\pm$ 20%	2	0.26	700	MLP2012S4R7MT0S1

\* Rated current: Current assumed when temperature has risen to 40°C max.

#### Measurement equipment

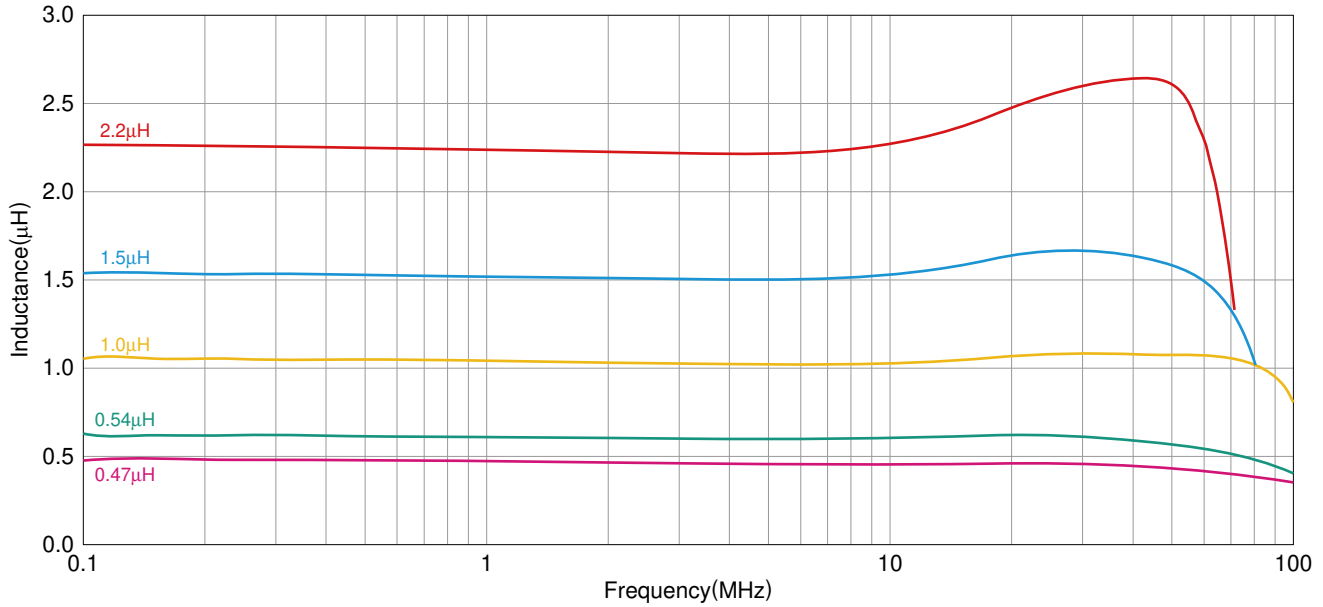
Measurement item	Product No.	Manufacturer
L	4294A+16034G	Keysight Technologies
DC resistance	Type-7561	Yokogawa

\* Equivalent measurement equipment may be used.

# MLP2012 Type (H characteristic product, T dimension of the product 1.0mm max.)

## ELECTRICAL CHARACTERISTICS


### L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

\* Equivalent measurement equipment may be used.

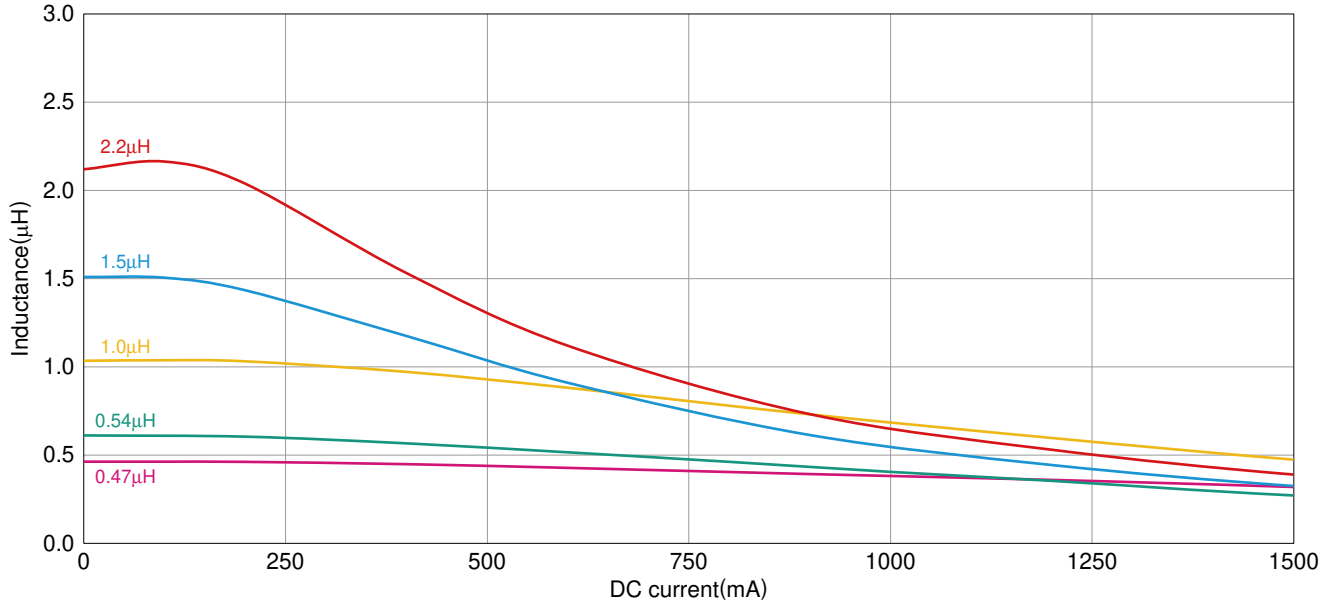
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# MLP2012 Type (H characteristic product, T dimension of the product 1.0mm max.)

## ELECTRICAL CHARACTERISTICS

### INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4285A+42841A+42842C+42851-61100	Keysight Technologies

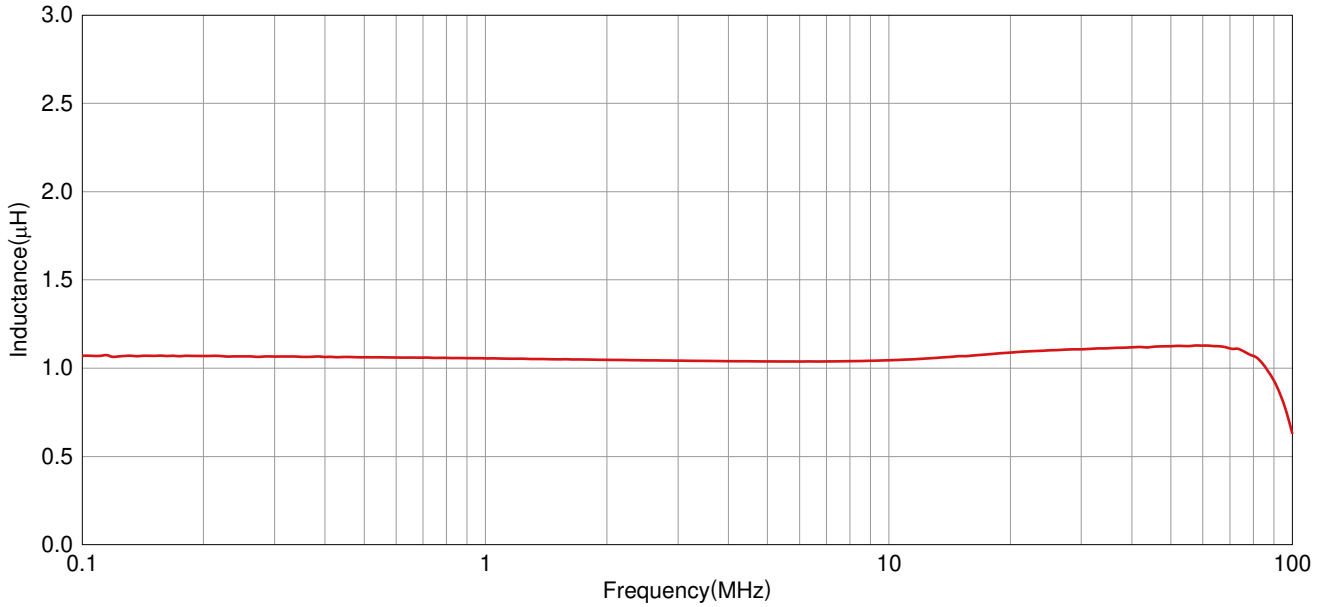
\* Equivalent measurement equipment may be used.

⚠ Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

# MLP2012 Type (V characteristic product, T dimension of the product 0.55mm max.)

## ELECTRICAL CHARACTERISTICS


### L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

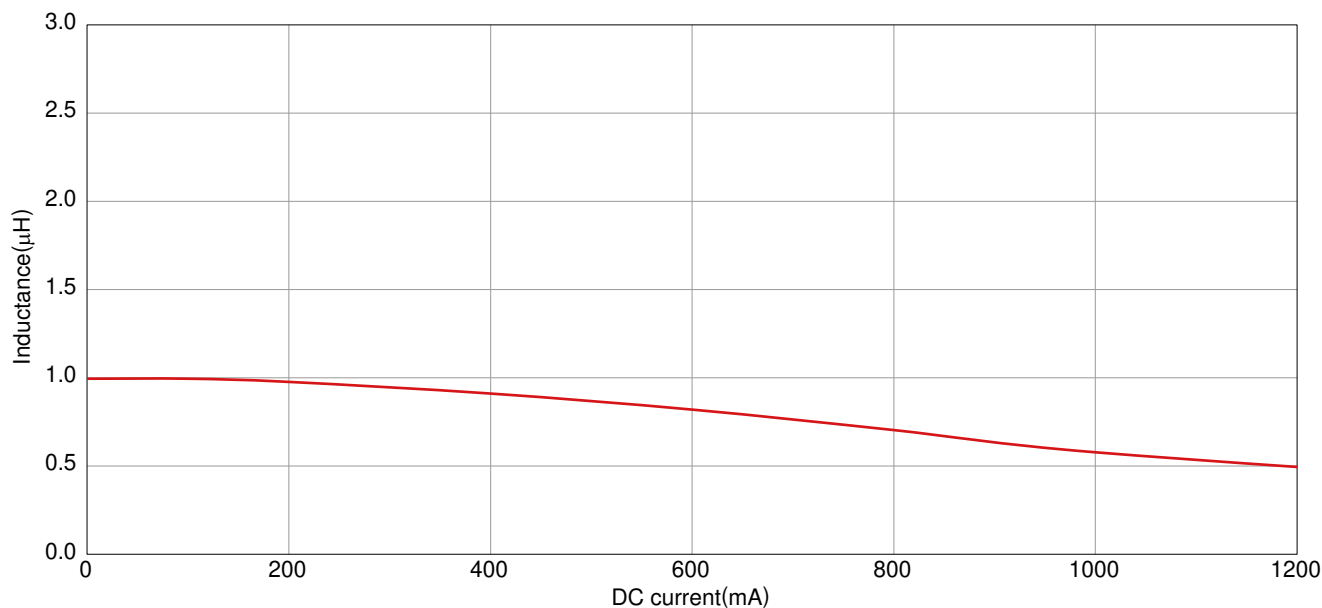
\* Equivalent measurement equipment may be used.

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

# MLP2012 Type (V characteristic product, T dimension of the product 0.55mm max.)

## ELECTRICAL CHARACTERISTICS

### INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

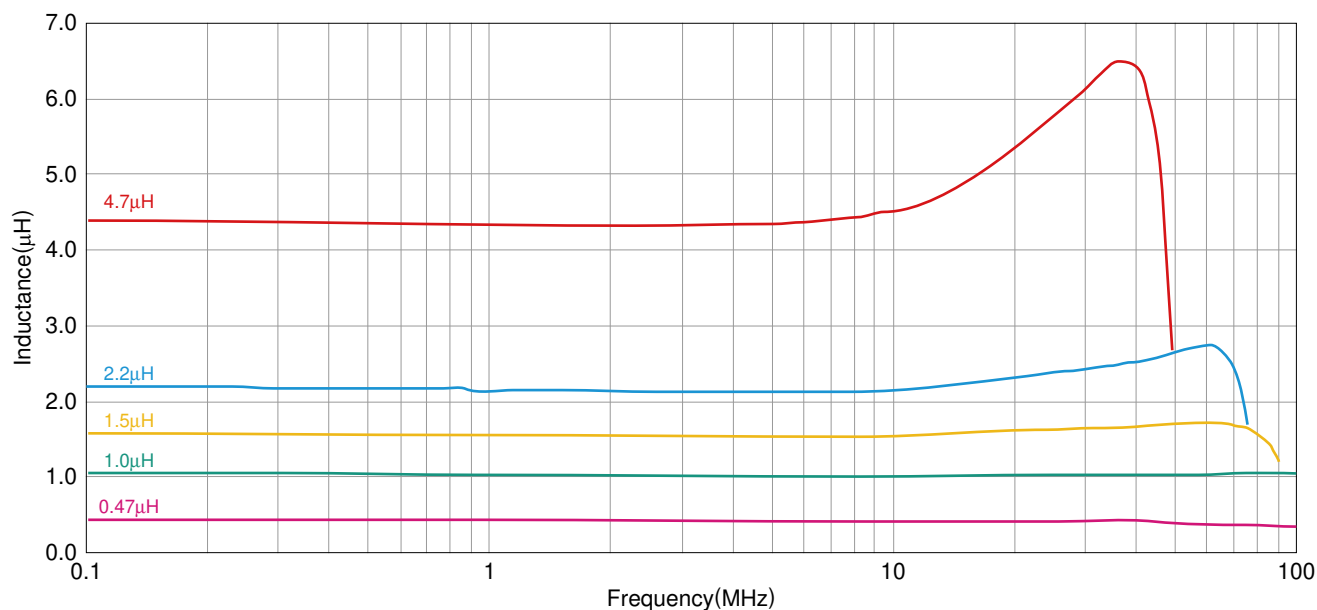
Product No.	Manufacturer
4285A+42841A+42842C+42851-61100	Keysight Technologies

\* Equivalent measurement equipment may be used.

# MLP2012 Type (V characteristic product, T dimension of the product 1.0mm max.)

## ELECTRICAL CHARACTERISTICS

### L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

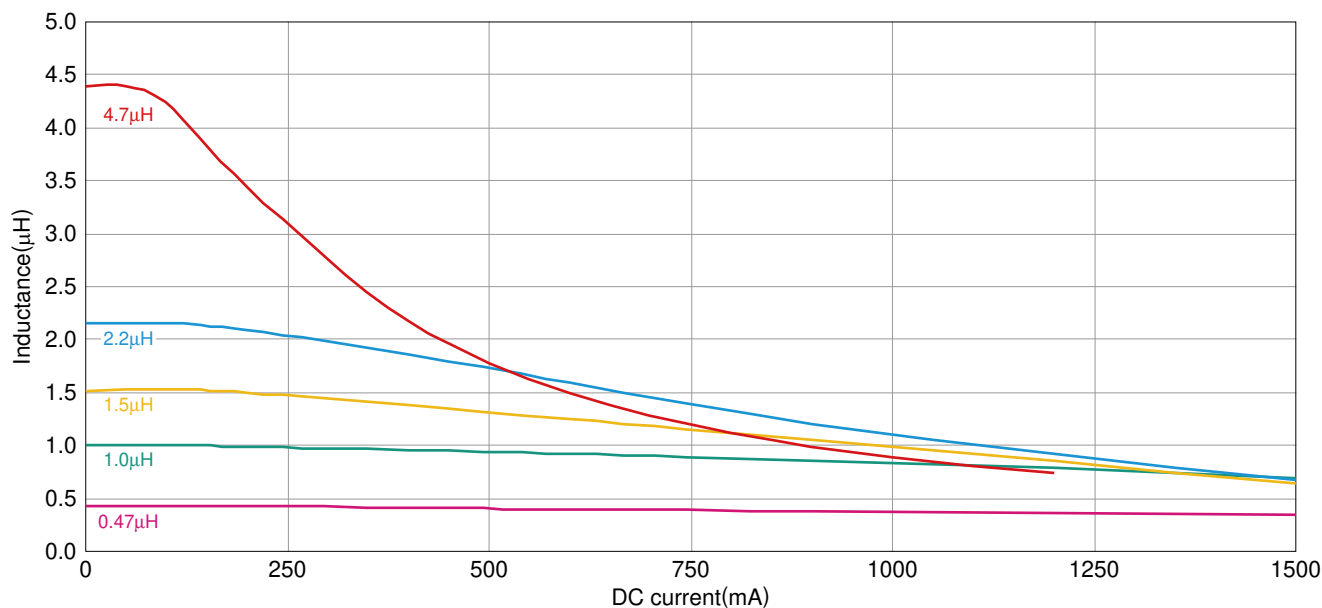
Product No.	Manufacturer
4294A+16034G	Keysight Technologies

\* Equivalent measurement equipment may be used.

# MLP2012 Type (V characteristic product, T dimension of the product 1.0mm max.)

## ELECTRICAL CHARACTERISTICS

### INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

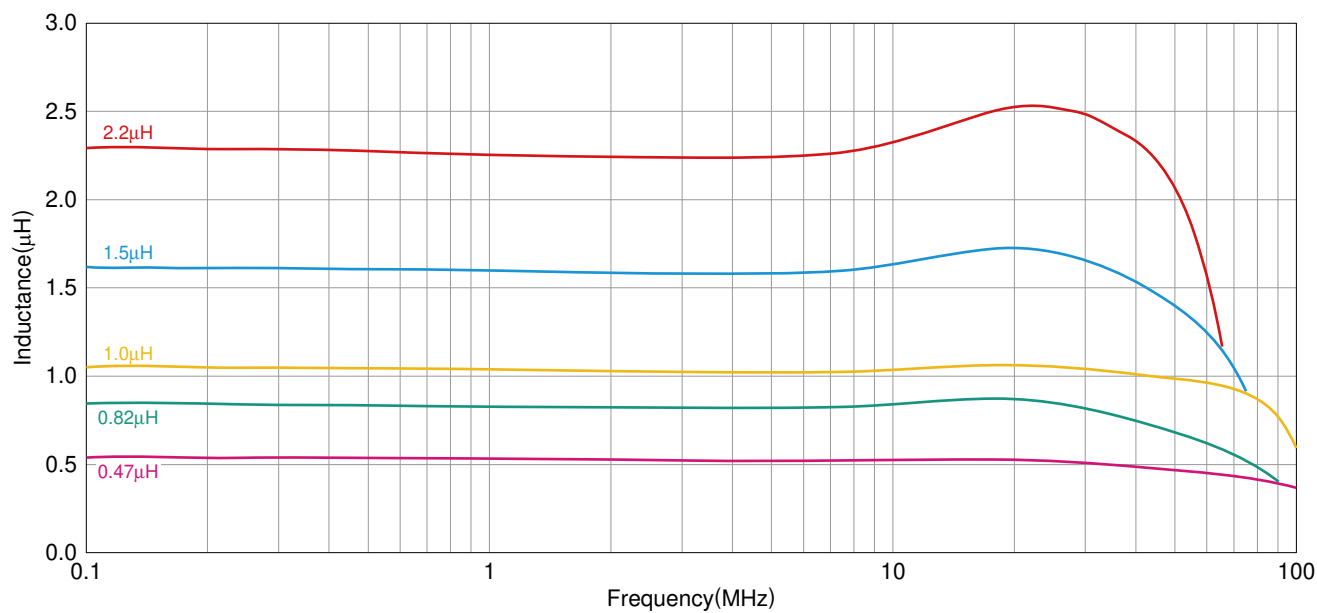
Product No.	Manufacturer
4285A+42841A+42842C+42851-61100	Keysight Technologies

\* Equivalent measurement equipment may be used.

# MLP2012 Type (S characteristic product, T dimension of the product 0.55mm max.)

## ELECTRICAL CHARACTERISTICS

### L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

\* Equivalent measurement equipment may be used.

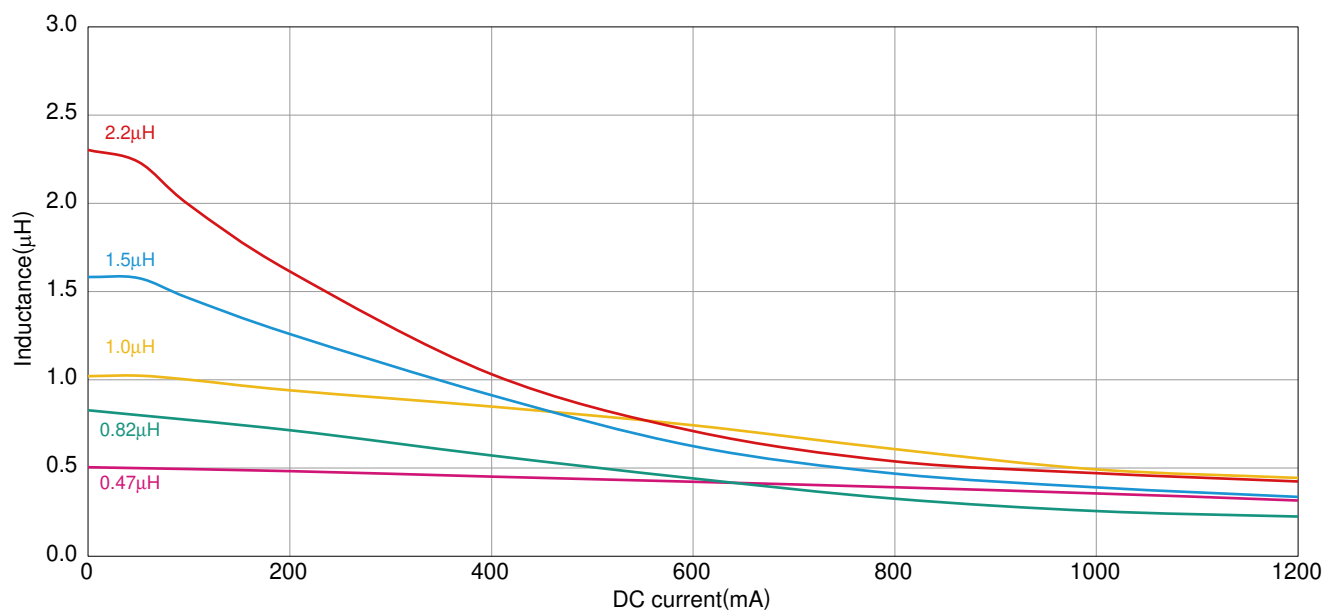
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# MLP2012 Type

(S characteristic product, T dimension of the product 0.55mm max.)

## ELECTRICAL CHARACTERISTICS

### INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

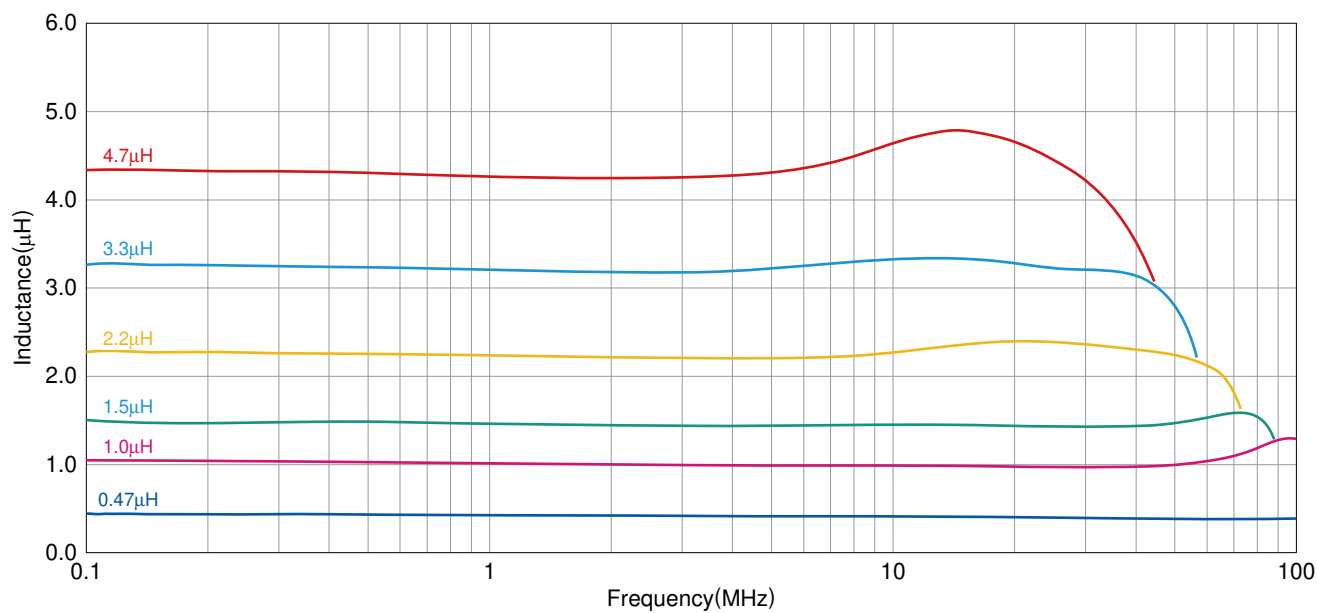
Product No.	Manufacturer
4285A+42841A+42842C+42851-61100	Keysight Technologies

\* Equivalent measurement equipment may be used.

# MLP2012 Type (S characteristic product, T dimension of the product 1.0mm max.)

## ELECTRICAL CHARACTERISTICS

### L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

\* Equivalent measurement equipment may be used.

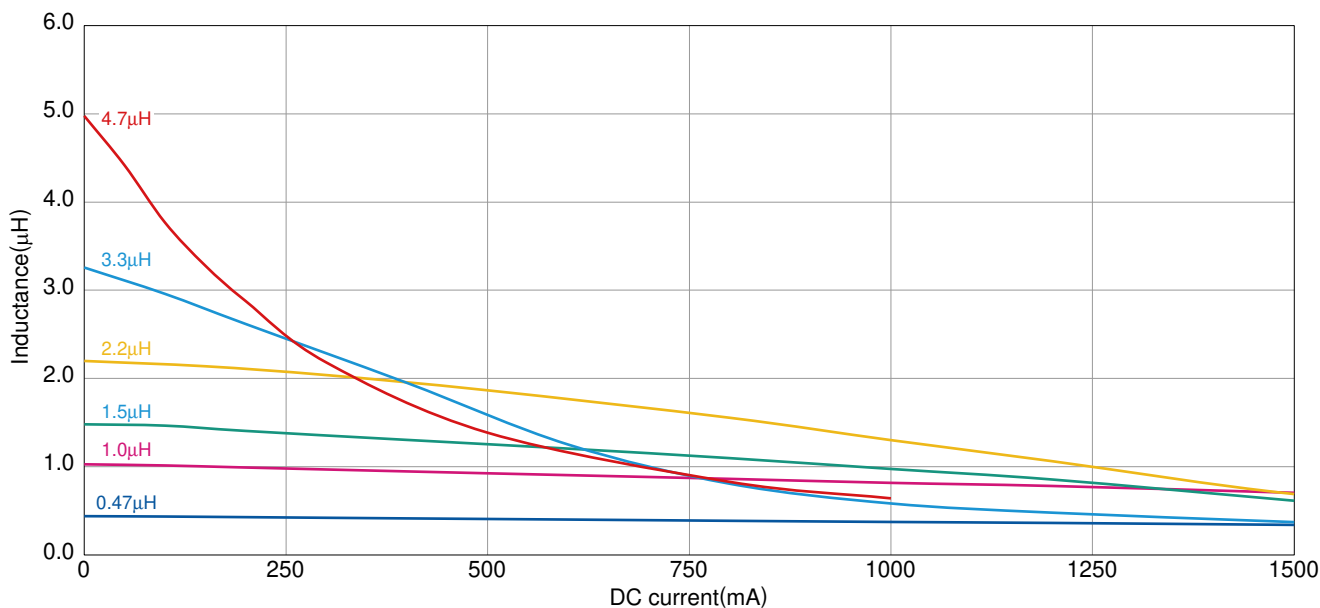
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# MLP2012 Type (S characteristic product, T dimension of the product 1.0mm max.)

## ELECTRICAL CHARACTERISTICS


### INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4285A+42841A+42842C+42851-61100	Keysight Technologies

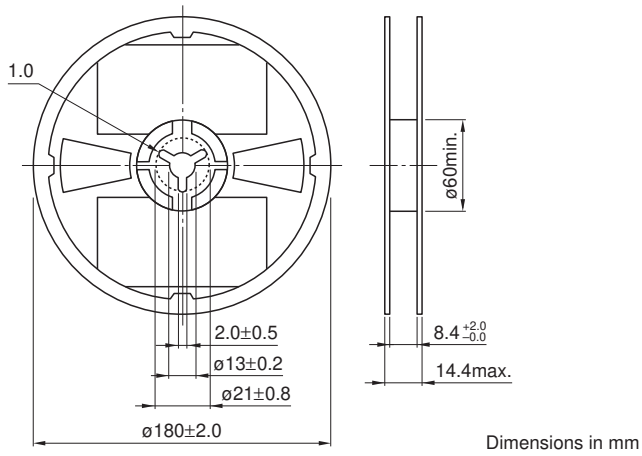
\* Equivalent measurement equipment may be used.

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

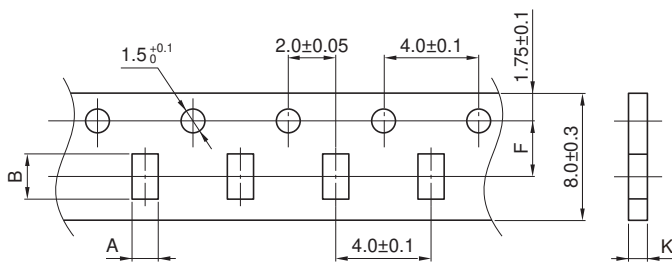
# MLP2012 Type

## PACKAGING STYLE

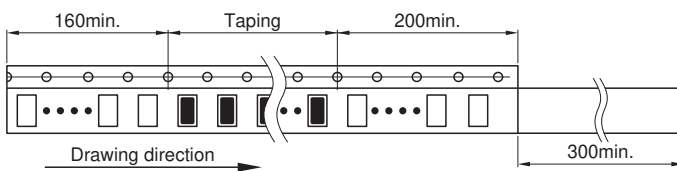
### REEL DIMENSIONS



### TAPE DIMENSIONS



Type	A	B	K
MLP2012	$1.5 \pm 0.2$	$2.3 \pm 0.2$	1.1 max.



Dimensions in mm